

## 250 VAC Non-Safety Rated AC Capacitors CAN series (Industrial Grade)

### Overview

KEMET's CAN series are non-safety rated ceramic capacitors designed for 250 VAC applications where higher CV values are required but not available in safety certified MLCCs. These capacitors are qualified for continuous use under AC line conditions of 250 VAC 50/60 Hz. Available in a variety of case sizes and industry leading CV values (capacitance/voltage), these devices exhibit low leakage current and low ESR at high frequencies.

For added reliability, KEMET's flexible termination technology is an available option that provides superior flex performance over standard termination systems. This series is available in X7R dielectric which exhibits a predictable change in capacitance with respect to time and voltage, and boasts a minimal change in capacitance with reference to ambient temperature. CAN series is specifically designed and tested for 50/60 Hz line frequencies and other non-safety critical applications.

### Benefits

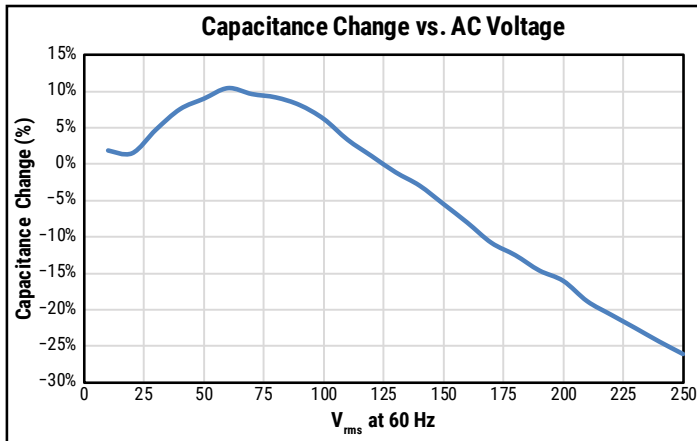
- Continuous AC voltage rating 250 V, 50/60 Hz
- Offers more than 50x capacitance versus Safety Rated MLCCs
- Base metal electrode (BME) dielectric system
- -55°C to +125°C operating temperature range
- Low ESR and ESL
- Lead (Pb)-free, RoHS, and REACH Compliant
- Temperature stable dielectric
- Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- Flexible termination option available upon request



### Applications

- AC-DC converters
- AC filtering
- Power factor correction
- Power supply

## Typical Performance - 2220, 330 nF, 250 VAC



## Electrical Parameters/Performance Characteristics

Item	Parameters/Characteristics
Operating temperature range	-55°C to +125°C
Capacitance change with reference to +25°C and 0 VDC applied (TCC)	±15%
<sup>1</sup> Aging rate (maximum % capacitance loss/decade hour)	3.0%
<sup>2</sup> Dielectric withstanding voltage (DWV)	945 VDC (5 ±1 seconds and charge/discharge not exceeding 50mA)
<sup>3</sup> Dissipation factor (DF) maximum limit at 25°C	2.5%
<sup>4</sup> Insulation resistance (IR) minimum limit at 25°C	100 megohm microfarads or 10 GΩ (500 VDC applied for 120 ±5 seconds at 25°C)

<sup>1</sup> Regarding Aging Rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours.

<sup>2</sup> DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

<sup>3</sup> Capacitance and dissipation factor (DF) measured under the following conditions:

1 kHz ±50 Hz and  $1.0 \pm 0.2 V_{rms}$  if capacitance ≤ 10 μF

120 Hz ±10 Hz and  $0.5 \pm 0.1 V_{rms}$  if capacitance > 10 μF

<sup>4</sup> To obtain IR limit, divide MΩ-μF value by the capacitance and compare to GΩ limit. Select the lower of the two limits.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON".

## Ordering Information

CAN	08	C	103	K	A	R	A	C	7XXX
Series	Case Size (L"x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (V)	Dielectric	Subclass Designation	Termination Finish	Packaging (Suffix/C-Spec)
CAN = Ceramic AC Non-Safety	08 = 0805 12 = 1206 13 = 1210 17 = 1808 18 = 1812 19 = 1825 21 = 2220 22 = 2225	C = Standard X = Flex	Two single digits and number of zeros.	J = ±5% K = ±10% M = ±20%	A = 250 VAC 50/60 Hz	R = X7R	A = N/A	C = 100% matte Sn	See "Packaging C-Spec Ordering Options Table"

See Table 1 for available capacitance and voltage ratings.

## Packaging C-Spec Ordering Options Table

Packaging Type	Packaging/Grade Ordering Code (C-Spec)
Bulk Bag <sup>1</sup>	Not Required (Blank)
7" Reel/Unmarked <sup>2</sup>	TU
13" Reel/Unmarked	7210
7" Reel/Marked <sup>2</sup>	TM
13" Reel/Marked	7215

<sup>1</sup> Default packaging is "Bulk Bag." An ordering code C-Spec is not required for "Bulk Bag" packaging.

<sup>2</sup> The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked.

## Dimensions – Millimeters (Inches)



### Standard Termination

Case Size	EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique	
08	0805	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder Wave or Solder Reflow	
12	1206	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)			0.60 (0.024) ±0.35 (0.014)		N/A
13	1210	3225	3.20 (0.126) ±0.20 (0.008)	2.50 (0.098) ±0.20 (0.008)					
17	1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)					
18	1812	4532	4.50 (0.177) ±0.30 (0.012)	3.20 (0.126) ±0.30 (0.012)					
19	1825	4564	4.50 (0.177) ±0.30 (0.012)	6.40 (0.252) ±0.40 (0.016)					
21	2220	5650	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016)					
22	2225	5664	5.60 (0.220) ±0.40 (0.016)	6.40 (0.252) ±0.40 (0.016)					

### Flexible Termination

Case Size	EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
08	0805	2012	2.00 (0.079) ±0.30 (0.012)	1.25 (0.049) ±0.30 (0.012)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder Wave or Solder Reflow
12	1206	3216	3.30 (0.130) ±0.40 (0.016)	1.60 (0.063) ±0.35 (0.013)		0.60 (0.024) ±0.25 (0.010)	N/A	
13	1210	3225	3.30 (0.130) ±0.40 (0.016)	2.60 (0.102) ±0.30 (0.012)				
17	1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)				
18	1812	4532	4.50 (0.178) ±0.40 (0.016)	3.20 (0.126) ±0.30 (0.012)				
19	1825	4564	4.60 (0.181) ±0.40 (0.016)	6.40 (0.252) ±0.40 (0.016)				
21	2220	5650	5.90 (0.232) ±0.75 (0.030)	5.00 (0.197) ±0.40 (0.016)				
22	2225	5664	5.90 (0.232) ±0.75 (0.030)	6.40 (0.252) ±0.40 (0.016)				

**Table 1 – Capacitance Range/Selection Waterfall (0805 – 2225 Case Sizes)**

Cap	Cap Code	Case Size/ Series			CAN08C/X 0805	CAN12C/X 1206	CAN13C/X 1210	CAN17C/X 1808	CAN18C/X 1812	CAN19C/X 1825	CAN21C/X 2220	CAN22C/X 2225
		Voltage Code			A							
		Rated Voltage (VAC)			250							
		Capacitance Tolerance			For product availability and chip thickness codes, see Table 2 for chip thickness dimensions.							
2,200 pF	222	J	K	M	DG							
2,700 pF	272	J	K	M	DG							
3,300 pF	332	J	K	M	DG							
3,900 pF	392	J	K	M	DG							
4,700 pF	472	J	K	M	DG							
5,600 pF	562	J	K	M	DG							
6,800 pF	682	J	K	M	DG							
8,200 pF	822	J	K	M	DG							
10,000 pF	103	J	K	M	DG							
12,000 pF	123	J	K	M	DG	EJ						
15,000 pF	153	J	K	M		EJ						
18,000 pF	183	J	K	M		EJ		LE				
22,000 pF	223	J	K	M		EJ	FZ	LE				
27,000 pF	273	J	K	M		EJ	FZ	LA	GB			
33,000 pF	333	J	K	M		EJ	FZ	LA	GB			
39,000 pF	393	J	K	M			FZ	LA	GB			
47,000 pF	473	J	K	M			FU	LB	GC			
56,000 pF	563	J	K	M			FU	LB	GE			
62,000 pF	623	J	K	M			FK	LC	GE			
68,000 pF	683	J	K	M			FK	LC	GE			
82,000 pF	823	J	K	M			FK	LC	GE			
0.10 µF	104	J	K	M			FS	LC	GH			
0.12 µF	124	J	K	M					GK			
0.15 µF	154	J	K	M					GN	HE		
0.18 µF	184	J	K	M						HE	JE	
0.22 µF	224	J	K	M						HG	JE	KE
0.27 µF	274	J	K	M						HJ	JK	KF
0.33 µF	334	J	K	M						HJ	JL	KH
											JN	KH
Cap	Cap Code	Rated Voltage (VAC)			250							
		Voltage Code			A							
		Case Size/ Series			CAN08C/X 0805	CAN12C/X 1206	CAN13C/X 1210	CAN17C/X 1808	CAN18C/X 1812	CAN19C/X 1825	CAN21C/X 2220	CAN22C/X 2225

**Table 2A – Chip Thickness/Tape & Reel Packaging Quantities**

Thickness Code	Case Size	EIA Size Code	Thickness ± Range (mm)	Plastic Quantity	
				7" Reel	13" Reel
DG	08	0805	1.25 ± 0.15	2,500	10,000
EJ	12	1206	1.70 ± 0.20	2,000	8,000
FZ	13	1210	1.25 ± 0.20	2,500	10,000
FU	13	1210	1.55 ± 0.20	2,000	8,000
FK	13	1210	2.10 ± 0.20	2,000	8,000
FS	13	1210	2.50 ± 0.30	1,000	4,000
LE	17	1808	1.00 ± 0.10	2,500	10,000
LA	17	1808	1.40 ± 0.15	1,000	4,000
LB	17	1808	1.60 ± 0.15	1,000	4,000
LC	17	1808	2.00 ± 0.15	1,000	4,000
GB	18	1812	1.00 ± 0.10	1,000	4,000
GC	18	1812	1.10 ± 0.10	1,000	4,000
GE	18	1812	1.30 ± 0.10	1,000	4,000
GH	18	1812	1.40 ± 0.15	1,000	4,000
GK	18	1812	1.60 ± 0.20	1,000	4,000
GN	18	1812	1.70 ± 0.20	1,000	4,000
HE	19	1825	1.40 ± 0.15	1,000	4,000
HG	19	1825	1.60 ± 0.20	1,000	4,000
HJ	19	1825	2.00 ± 0.20	500	2,000
JE	21	2220	1.40 ± 0.15	1,000	4,000
JK	21	2220	1.60 ± 0.20	1,000	4,000
JL	21	2220	2.00 ± 0.20	500	2,000
JN	21	2220	2.50 ± 0.20	500	2,000
KE	22	2225	1.40 ± 0.15	1,000	4,000
KF	22	2225	1.60 ± 0.20	1,000	4,000
KH	22	2225	2.00 ± 0.20	500	2,000

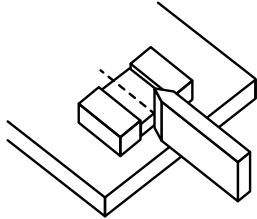
Package quantity based on finished chip thickness specifications.

**Table 2B – Bulk Packaging Quantities**

Packaging Type		Loose Packaging	
		Bulk Bag (default)	
Packaging C-Spec <sup>1</sup>		N/A <sup>2</sup>	
Case Size		Packaging Quantities (pieces/unit packaging)	
CAN	EIA (in)	Minimum	Maximum
08	0805	1	50,000
12	1206		
13	1210		
17	1808		20,000
18	1812		
19	1825		
21	2220		
22	2225		

For Industrial grade products ordered without a packaging, C-Spec will default to our standard "Bulk Bag" packaging.

**Table 3 – Performance & Reliability: Test Methods and Conditions**

Stress	Reference	Test or Inspection Method													
Terminal Strength	AEC-Q200-006	Shear force per specific case size; Time: 60 ±1 second													
		<table border="1"> <thead> <tr> <th>Case Size</th> <th>EIA Size Code</th> <th>Force</th> </tr> </thead> <tbody> <tr> <td>08</td> <td>0805</td> <td>10 N</td> </tr> <tr> <td>12</td> <td>1206</td> <td>10 N</td> </tr> <tr> <td>13</td> <td>1210</td> <td>10 N</td> </tr> <tr> <td>≥ 17</td> <td>≥ 1808</td> <td>18 N</td> </tr> </tbody> </table> 	Case Size	EIA Size Code	Force	08	0805	10 N	12	1206	10 N	13	1210	10 N	≥ 17
Case Size	EIA Size Code	Force													
08	0805	10 N													
12	1206	10 N													
13	1210	10 N													
≥ 17	≥ 1808	18 N													
Board Flex	AEC-Q200-005	Standard termination system 2.0 mm (minimum) Flexible termination system and COG Dielectric (minimum)													
Solderability	J-STD-002	Magnification 50 X. Conditions:													
		a) Method B, 4 hours at 155°C, dry heat at 235°C													
		b) Method B, category 3, at 215°C													
		c) Method D, category 3, at 260°C													
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C). Measurement at 24 hours ±4 hours after test conclusion.													
Biased Humidity	MIL-STD-202 Method 103	Load humidity: 1,000 hours 85°C/85% RH and 200 VDC maximum. Add 100 KΩ resistor. Measurement at 24 hours ±4 hours after test conclusion.													
		Low volt humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 KΩ resistor. Measurement at 24 hours ±4 hours after test conclusion.													
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours ±4 hours after test conclusion.													
AC Rated Life Test	KEMET Custom Test	1,000 hours at 125°C 250 V <sub>rms</sub> 50/60 Hz Measurement at 24 hours ±2 hours after test conclusion.													
Storage Life	MIL-STD-202 Method 108	125°C, 0 VDC, for 1,000 hours													
Vibration	MIL-STD-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" x 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz													
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F													
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent													

## Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

**Table 4 – Land Pattern Design Recommendations per IPC-7351**

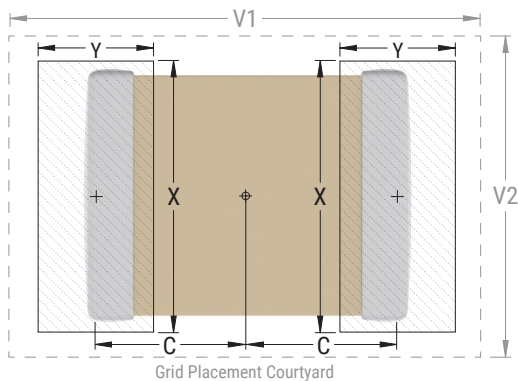
EIA Size Code	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)				
		C	Y	X	V1	V2	C	Y	X	V1	V2	C	Y	X	V1	V2
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	1.50	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
1825	4564	2.15	1.60	6.90	6.90	7.90	2.05	1.40	6.80	6.00	7.30	1.95	1.20	6.70	5.30	7.00
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60
2225	5664	2.70	1.70	6.90	8.10	7.90	2.60	1.50	6.80	7.20	7.30	2.50	1.30	6.70	6.50	7.00

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

**Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations, the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.





## Soldering Process

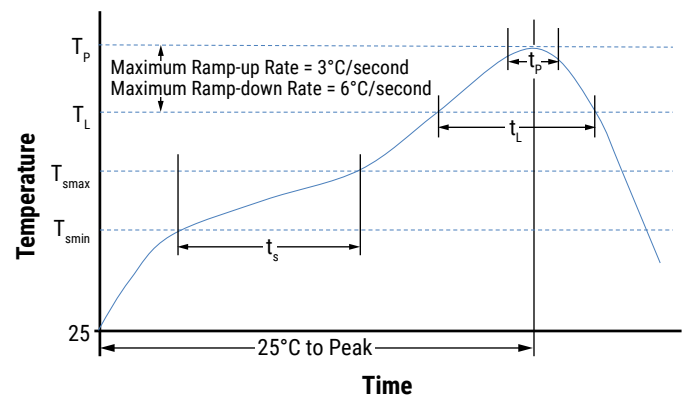
### Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0805 and 1206
- All other EIA case sizes are limited to solder reflow only

### Recommended Reflow Soldering:

KEMET's family of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish
	100% matte Sn
<b>Preheat/Soak</b>	
Temperature Minimum ( $T_{Smin}$ )	150°C
Temperature Maximum ( $T_{Smax}$ )	200°C
Time ( $t_s$ ) from $T_{Smin}$ to $T_{Smax}$	60 – 120 seconds
Ramp-Up Rate ( $T_L$ to $T_p$ )	3°C/second maximum
Liquidous Temperature ( $T_L$ )	217°C
Time Above Liquidous ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )	260°C
Time Within 5°C of Maximum Peak Temperature ( $t_p$ )	30 seconds maximum
Ramp-Down Rate ( $T_p$ to $T_L$ )	6°C/second maximum
Time 25°C to Peak Temperature	8 minutes maximum

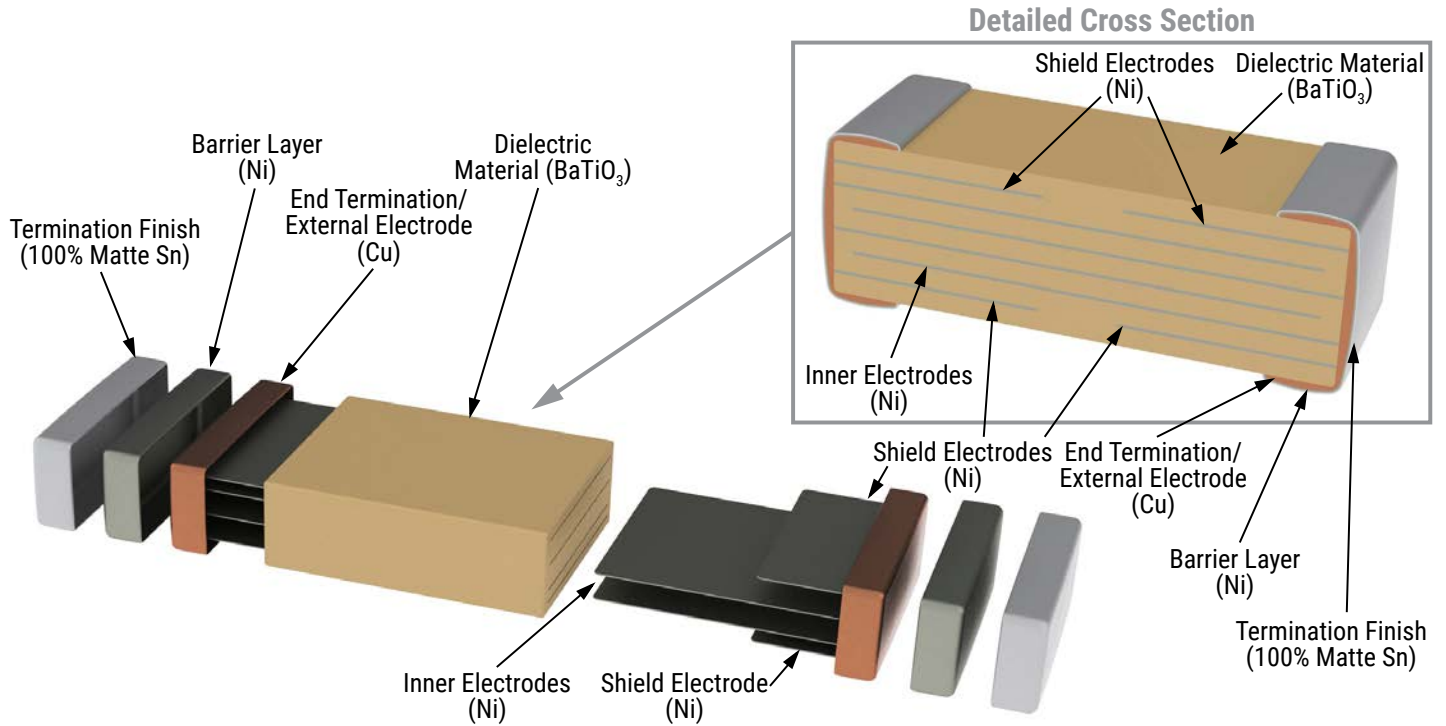


Note: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

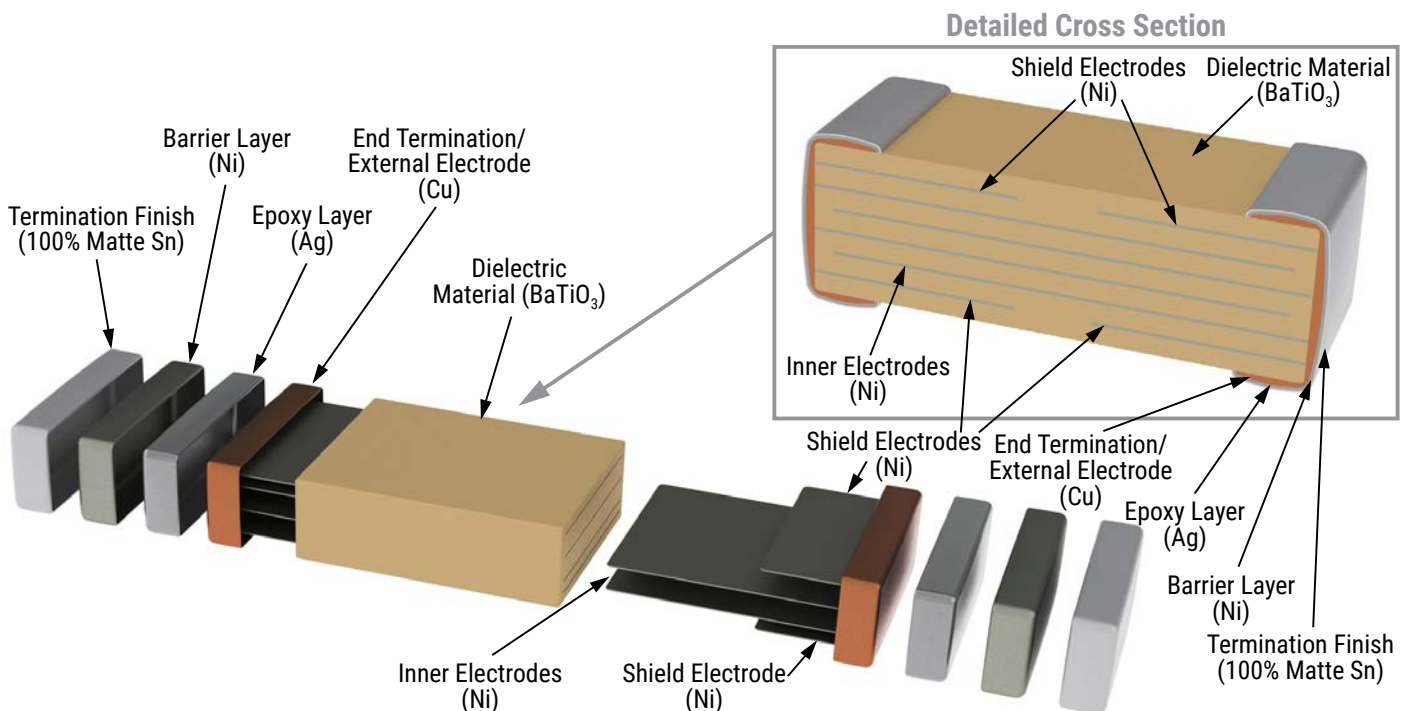
## Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. Packaging materials will be degraded by high temperature – reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years upon receipt.

## Construction – Standard Termination



## Construction – Flexible Termination



## Capacitor Marking (Optional):

These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices, but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a “K” to identify KEMET, followed by two characters (per EIA-198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the “K” character only.

Laser marking option is not available on:

- C0G, ultra stable X8R and Y5V dielectric devices.
- EIA 0402 case size devices.
- EIA 0603 case size devices with flexible termination option.
- KPS commercial and automotive grade stacked devices.
- X7R dielectric products in capacitance values outlined below.

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of “KA8”, which designates a KEMET device with rated capacitance of 100  $\mu$ F. Orientation of marking is vendor optional.



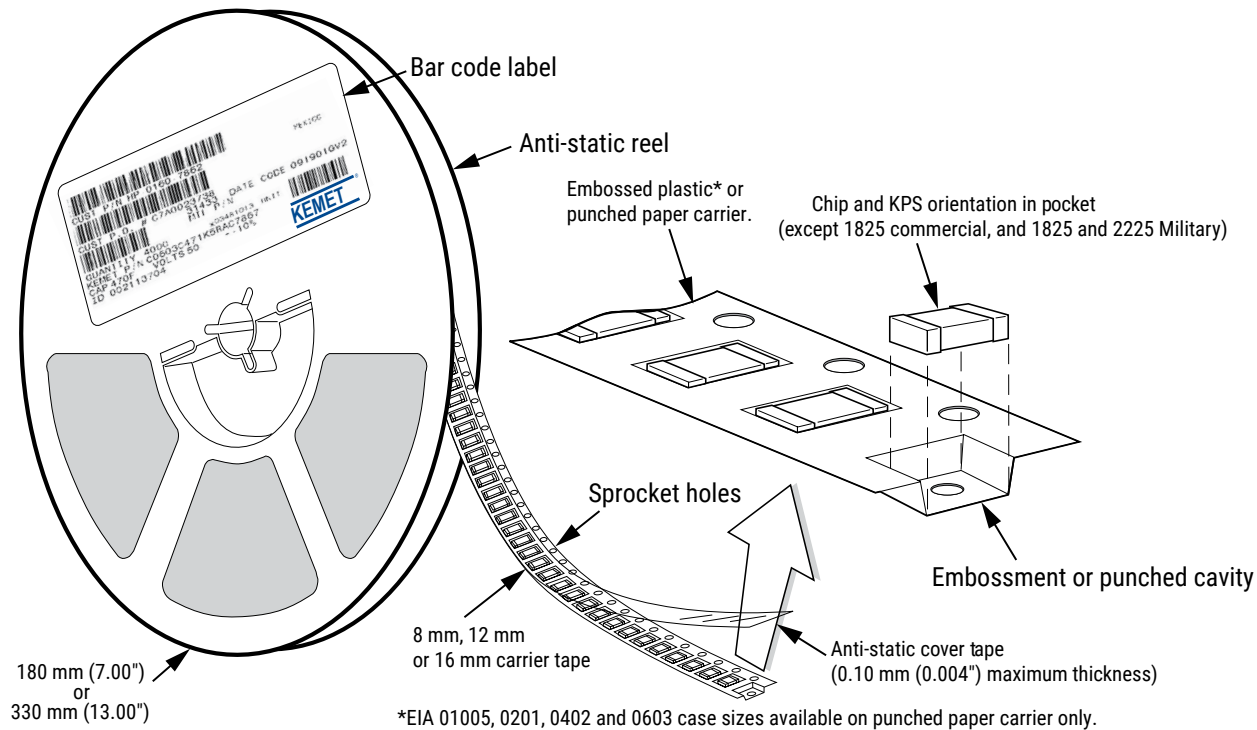
EIA Case Size	Metric Size Code	Capacitance
0805	2012	$\leq 150$ pF
1206	3216	$\leq 910$ pF
1210	3225	$\leq 2,000$ pF
1808	4520	$\leq 3,900$ pF
1812	4532	$\leq 6,700$ pF
1825	4564	$\leq 0.018$ $\mu$ F
2220	5650	$\leq 0.027$ $\mu$ F
2225	5664	$\leq 0.033$ $\mu$ F

## Capacitor Marking (Optional) cont'd

Capacitance (pF) For Various Alpha/Numeral Identifiers										
Alpha Character	Numeral									
	9	0	1	2	3	4	5	6	7	8
Capacitance (pF)										
A	0.10	1.0	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000
B	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000
C	0.12	1.2	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000
D	0.13	1.3	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000
E	0.15	1.5	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000
F	0.16	1.6	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000
G	0.18	1.8	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000
H	0.20	2.0	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000
J	0.22	2.2	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000
K	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000
M	0.30	3.0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000
N	0.33	3.3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000
P	0.36	3.6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000
Q	0.39	3.9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000
R	0.43	4.3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000
T	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000
U	0.56	5.6	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000
V	0.62	6.2	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000
W	0.68	6.8	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000
X	0.75	7.5	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000
Y	0.82	8.2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000
a	0.25	2.5	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000
b	0.35	3.5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000
d	0.40	4.0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000
e	0.45	4.5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000
f	0.50	5.0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000
m	0.60	6.0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,000
n	0.70	7.0	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,000
t	0.80	8.0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000
y	0.90	9.0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000

## Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.



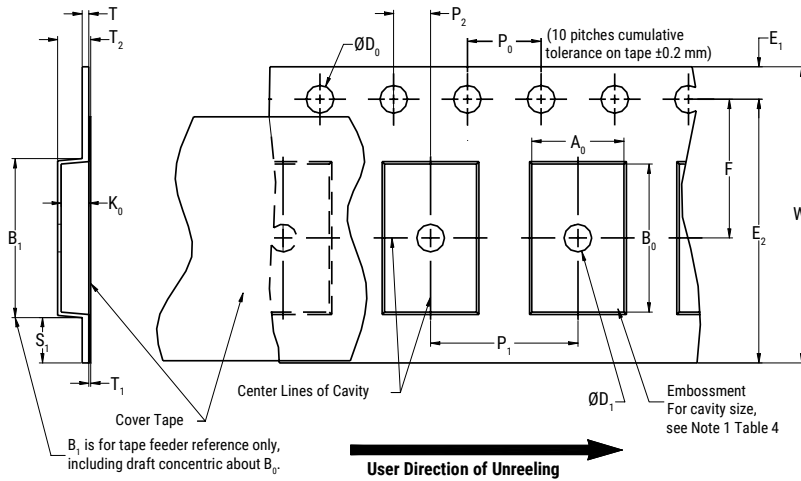
**Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)**

EIA Case Size	Tape Size (W)*	Embossed Plastic		Punched Paper	
		7" Reel	13" Reel	7" Reel	13" Reel
		Pitch (P <sub>1</sub> )*		Pitch (P <sub>1</sub> )*	
0805	8	4	4	4	4
1206 – 1210	8	4	4	4	4
1805 – 1808	12	4	4		
≥ 1812	12	8	8		

\*Refer to Figures 1 and 2 for W and P<sub>1</sub> carrier tape reference locations.

\*Refer to Tables 7 and 8 for tolerance specifications.

**Figure 1 – Embossed (Plastic) Carrier Tape Dimensions**



**Table 6 – Embossed (Plastic) Carrier Tape Dimensions**

Metric will govern

Constant Dimensions – Millimeters (Inches)									
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T <sub>1</sub> Maximum
8 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)				30 (1.181)			
16 mm						30.0 (1.181)	5.0 (0.196)	0.250 (0.009)	0.350 (0.013)
24 mm									
Variable Dimensions – Millimeters (Inches)									
Tape Size	Pitch	B <sub>1</sub> Maximum Note 4	E <sub>2</sub> Minimum	F	P <sub>1</sub>	T <sub>2</sub> Maximum	W Maximum	A <sub>0</sub> , B <sub>0</sub> & K <sub>0</sub>	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)	Note 5	
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)		
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		
24 mm	16 mm	11.5 (0.452)	22.25 (0.875)	11.5 ±0.10 (0.452 ±0.003)	16.0 ±0.10 (0.629 ±0.004)	3 (0.118)	24.3 (0.956)		

- The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.
- The tape with or without components shall pass around R without damage (see Figure 6).
- If  $S_1 < 1.0$  mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)
- $B_1$  dimension is a reference dimension for tape feeder clearance only.
- The cavity defined by  $A_0$ ,  $B_0$  and  $K_0$  shall surround the component with sufficient clearance that:
  - the component does not protrude above the top surface of the carrier tape.
  - the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
  - lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
  - for KPS product,  $A_0$  and  $B_0$  are measured on a plane 0.3 mm above the bottom of the pocket.
  - see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

## Packaging Information Performance Notes

- Cover Tape Break Force:** 1.0 kg minimum.
- Cover Tape Peel Strength:** The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

- Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

## Figure 2 – Maximum Component Rotation



## Figure 3 – Maximum Lateral Movement



## Figure 4 – Bending Radius



**Figure 5 – Reel Dimensions**



Note: Drive spokes optional; if used, dimensions B and D shall apply.

**Table 7 – Reel Dimensions**

Metric will govern

Constant Dimensions – Millimeters (Inches)				
Tape Size	A	B Minimum	C	D Minimum
8 mm	178 ±0.20 (7.008 ±0.008) or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)
12 mm				
16 mm				
24 mm		1.2 (0.047)	13.0 ±0.2 (0.521 ±0.008)	21 (0.826)
Variable Dimensions – Millimeters (Inches)				
Tape Size	N Minimum	$W_1$	$W_2$ Maximum	$W_3$
8 mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape width without interference
12 mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	
24 mm		25 +1.0/-0.0 (0.984 +0.039/-0.0)	27.4 +1.0/-1.0 (1.078 +0.039/-0.039)	



**Figure 6 – Tape Leader & Trailer Dimensions**



**Figure 7 – Maximum Camber**



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